TOSHIBA

TOSHIBA Intelligent Power Device High Voltage Monolithic Silicon Power IC

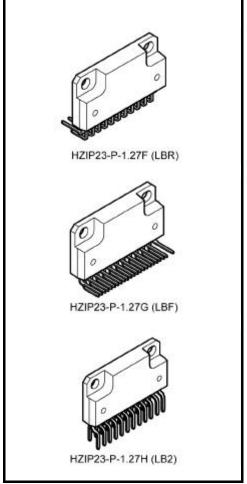
# **TPD4113AK**

The TPD4113AK is a DC brush less motor driver using high voltage PWM control. It is fabricated by high voltage SOI process. It contains level shift high-side driver, low-side driver, IGBT outputs, FRDs and protective functions for under voltage protection circuits and thermal shutdown circuit. It is easy to control a DC brush less motor by just putting logic inputs from a MPU or motor controller to the TPD4113AK.

#### **Features**

- Bootstrap circuit gives simple high side power supply.
- Bootstrap diodes are built in.
- A dead time can be set as a minimum of 1.4  $\mu s,$  and it is the best for a Sine-wave from drive.
- 3-phase bridge output using IGBTs.
- FRDs are built in.
- Included under voltage protection and thermal shutdown.
- $\bullet \quad$  The regulator of 7V (typ.) is built in.
- Package: 23-pin HZIP.

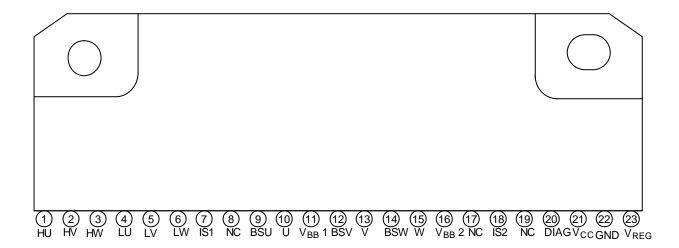
This product has a MOS structure and is sensitive to electrostatic discharge. When handling this product, ensure that the environment is protected against electrostatic discharge.



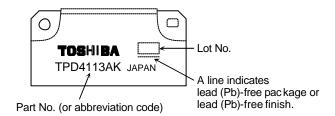
Weight

HZIP23-P-1.27F : 6.1 g (typ.) HZIP23-P-1.27G : 6.1 g (typ.) HZIP23-P-1.27H : 6.1 g (typ.)

## **Pin Assignment**



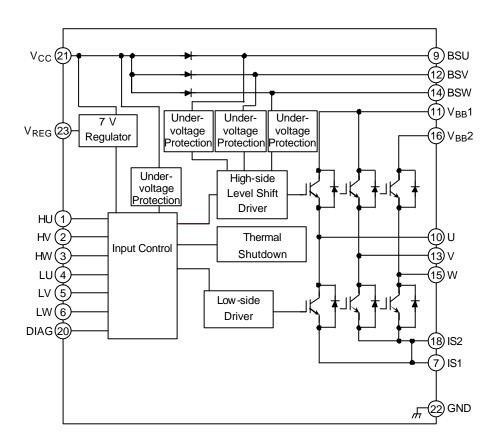
## Marking



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## **Block Diagram**





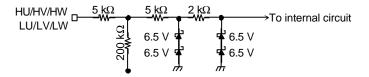
## **Pin Description**

Pin No.	Symbol	Pin Description					
1	HU	The control terminal of IGBT by the side of U top arm. It turns off more than by 1.5V. It turns on more than by 3.5V.					
2	HV	The control terminal of IGBT by the side of V top arm. It turns off more than by 1.5V. It turns on more than by 3.5V.					
3	HW	The control terminal of IGBT by the side of W top arm. It turns off more than by 1.5V. It turns on more than by 3.5V.					
4	LU	The control terminal of IGBT by the side of U bottom arm. It turns off more than by 1.5V. It turns on more than by 3.5V.					
5	LV	The control terminal of IGBT by the side of V bottom arm. It turns off more than by 1.5V. It turns on more than by 3.5V.					
6	LW	The control terminal of IGBT by the side of W bottom am. It turns off more than by 1.5V. It turns on more than by 3.5V.					
7	IS1	IGBT emitter and FRD anode pin.					
8	NC	Unused pin, which is not connected to the chip internally.					
9	BSU	J-phase bootstrap capacitor connecting pin.					
10	U	J-phase output pin.					
11	V <sub>BB1</sub>	J and V-phase high-voltage power supply input pin.					
12	BSV	V-phase bootstrap capacitor connecting pin.					
13	V	V-phase output pin.					
14	BSW	W-phase bootstrap capacitor connecting pin.					
15	W	W-phase output pin.					
16	V <sub>BB2</sub>	W-phase high-voltage power supply input pin.					
17	NC	Unused pin, which is not connected to the chip internally.					
18	IS2	IGBT emitter and FRD anode pin.					
19	NC	Unused pin, which is not connected to the chip internally.					
20	DIAG	With the diagnostic output terminal of open drain , a pull-up is carried out by resistance. It turns it on at the time of unusual.					
21	V <sub>CC</sub>	Control power supply pin.(15V typ.)					
22	GND	Ground pin.					
23	$V_{REG}$	7V regulator output pin.					

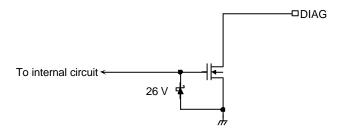


## **Equivalent Circuit of Input Pins**

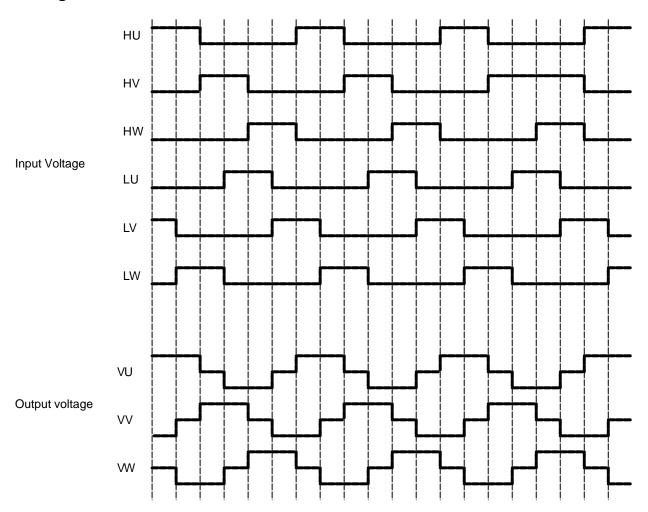
### Internal circuit diagram of HU, HV, HW, LU, LV, LW input pins



## Internal circuit diagram of DIAG pin



# **Timing Chart**



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### **Truth Table**

Mode	Input						Top arm			Bottom arm			
	ΗU	Η۷	нw	LU	LV	LW	U	V	W	U	V	W	DIAG
	пυ	пν	□ ٧٧	LU	LV	L VV	phase	phase	phase	phase	phase	phase	
Normal	Н	L	L	L	Н	L	ON	OFF	OFF	OFF	ON	OFF	OFF
	Н	L	L	L	L	Н	ON	OFF	OFF	OFF	OFF	ON	OFF
	L	Η	L	L	L	Н	OFF	ON	OFF	OFF	OFF	ON	OFF
	L	Η	L	Η	L	L	OFF	ON	OFF	ON	OFF	OFF	OFF
	L	L	Η	Η	L	L	OFF	OFF	ON	ON	OFF	OFF	OFF
	L	L	Η	L	Ι	L	OFF	OFF	ON	OFF	ON	OFF	OFF
Thermal shutdowr	Н	L	L	L	Ι	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	L	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	Η	L	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	Η	L	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	L	Η	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
Under voltage	Н	L	L	L	Η	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	L	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	Н	L	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	Н	L	L	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	L	Н	L	OFF	OFF	OFF	OFF	OFF	OFF	ON

 $Notes: Release \ of \ Thermal \ shutdown \ protection \ and \ under \ voltage \ protection \ depends \ release \ of \ a \ self-reset \ .$ 

## Absolute Maximum Ratings (Ta = 25°C)

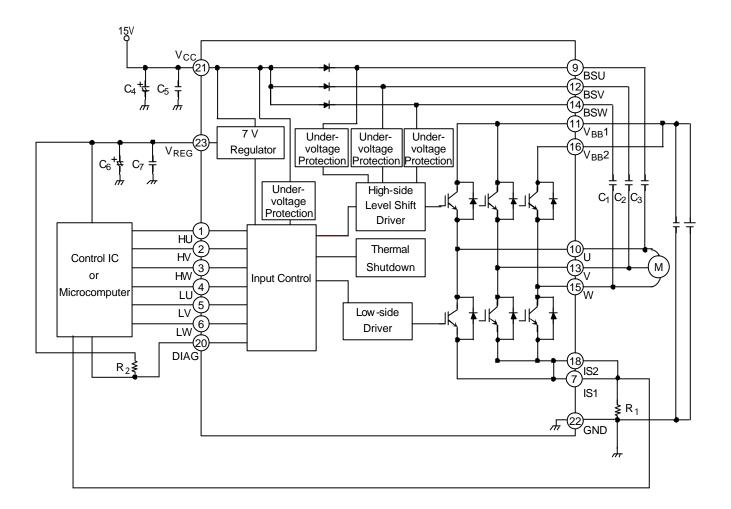
Characteristics	Symbol	Rating	Unit	
Power supply voltage	$V_{BB}$	500	V	
rower supply voltage	Vcc	18	V	
Output current (DC)	l <sub>out</sub>	1	Α	
Output current (pulse)	l <sub>out</sub>	2	Α	
Input voltage	V <sub>IN</sub>	-0.5~7	V	
V <sub>REG</sub> current	I <sub>REG</sub>	50	mA	
V <sub>DIAG</sub> current	I <sub>DIAG</sub>	20	mA	
Power dissipation (Ta = 25°C)	PC	4	W	
Power dissipation (Tc = 25°C)	PC	20	W	
Operating temperature	T <sub>jopr</sub>	-20~135	°C	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55~150	°C	
Lead-heat sink isolation voltage	Vhs	1000 (1 min)	Vrms	

# Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit		
Operating power supply voltage	$V_{BB}$	_	50	280	450	V		
Operating power supply voltage	V <sub>CC</sub>	_	13.5	15	16.5	v		
	I <sub>BB</sub>	V <sub>BB</sub> = 400 V	_	0	0.5	mA		
Current dissipation	lcc	V <sub>CC</sub> = 15 V	_	1.1	5	IIIA		
Current dissipation	I <sub>BS (ON)</sub>	V <sub>BS</sub> = 15 V, high side ON	_	260	410	μΑ		
	I <sub>BS (OFF)</sub>	V <sub>BS</sub> = 15 V, high side OFF	_	230	370	μΑ		
Input voltage	V <sub>IH</sub>	V <sub>IN</sub> = "H"	3.5	_	_	V		
Input voltage	$V_{IL}$	V <sub>IN</sub> = "L"	_	_	1.5	V		
Input current	۱н	$V_{IN} = 5V$		_	150	μΑ		
input current	I <sub>I</sub> L	$V_{IN} = 0 V$		_	100			
Output saturation voltage	V <sub>CEsat</sub> H	V <sub>CC</sub> = 15 V, IC = 0.5 A		2.3	.3 3 <sub>V</sub>			
Output Saturation voltage	V <sub>CEsat</sub> L	$V_{CC} = 15 V, IC = 0.5 A$		2.3	3	V		
FRD forward voltage	$V_{F}H$	IF = 0.5 A, high side		1.6	2.0	V		
T ND lot ward voltage	$V_{F}L$	IF = 0.5 A, low side		1.6	2.0	V		
Regulator voltage	$V_{REG}$	$V_{CC} = 15 \text{ V}, I_{O} = 30 \text{ mA}$	6.5	7	7.5	V		
BSD forward voltage	V <sub>F</sub> (BSD)	IF = 500 μ A	_	0.9	1.2	V		
Thermal shutdown temperature	TSD	V <sub>CC</sub> = 15 V	135		185			
Thermal shutdown hysteresis	ΔTSD	V <sub>CC</sub> = 15 V		50				
V <sub>CC</sub> under voltage protection	V <sub>CC</sub> UVD	_	10	11	12	V		
V <sub>CC</sub> under voltage protection recovery	$V_{CC}UVR$	_	10.5	11.5	12.5	V		
V <sub>BS</sub> under voltage protection	$V_{BS}UVD$	_	8	9	9.5	V		
V <sub>BS</sub> under voltage protection recovery	V <sub>BS</sub> UVR	_	8.5	9.5	10.5	V		
DIAG saturation voltage	V <sub>DIAGsat</sub>	I <sub>DIAG</sub> =5mA	_	_	0.5	V		
Output on delay time	t <sub>on</sub>	$V_{BB} = 280 \text{ V}, IC = 0.5 \text{ A}$		1.5	3	μs		
Output off delay time	t <sub>off</sub>	$V_{BB} = 280 \text{ V}, IC = 0.5 \text{ A}$	_	1.2	3	μs		
Dead time	tdead	$V_{BB} = 280  V,  IC = 0.5  A$	1.4	_	_	μs		
FRD reverse recovery time	t <sub>rr</sub>	$V_{BB} = 280  V$ , IC = 0.5 A	_	200		ns		

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## **Application Circuit Example**



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#### **External Parts**

Standard external parts are shown in the following table.

Part	Recommended Value	Purpose	Remarks	
C <sub>1</sub> , C <sub>2</sub> , C <sub>3</sub>	25 V/2.2 μF	Bootstrap capacitor	(Note 1)	
R <sub>1</sub>	0.62 $\Omega$ ± 1% (1 W)	Current detection	(Note 2)	
C <sub>4</sub>	25 V/10 μF	V <sub>CC</sub> power supply stability	(Note 3)	
C <sub>5</sub>	25 V/0.1 μF	V <sub>CC</sub> for surge absorber	(Note 3)	
C <sub>6</sub>	16 V/1 μF	V <sub>REG</sub> power supply stability	(Note 3)	
C <sub>7</sub>	16 V/1000 pF	V <sub>REG</sub> for surge absorber	(Note 3)	
R <sub>3</sub>	5.1 kΩ	DIAG pin pull-up resistor	(Note 4)	

- Note 1: The required bootstrap capacitance value varies according to the motor drive conditions. The capacitor is biased by V<sub>CC</sub> and must be sufficiently derated for it.
- Note 2: The following formula shows the detection current:  $I_O = V_R \div RIS$  (For  $V_R = 0.5 \text{ V}$ )

  Do not exceed a detection current of 1A when using this product.

  (Please go from the outside in the over current protection.)
- Note 3: When using this product, some adjustment is required in accordance with the use environment. When mounting, place as close to the base of this product leads as possible to improve the ripple and noise elimination.
- Note 4: The DIAG pin is open drain. Note that when the DIAG pin is connected to a power supply with a voltage higher than or equal to the V<sub>CC</sub>, a protection circuit is triggered so that the current flows continuously. If not using the DIAG pin, connect to the GND.

### Handling precautions

- (1) Please control the input signal in the state to which the V CC voltage is steady. Both of the order of the VBB power supply and the V CC power supply are not cared about either. Note that if the power supply is switched off as described above, this product may be destroyed if the current regeneration route to the V BB power supply is blocked when the V BB line is disconnected by a relay or similar while the motor is still running.
- (2) The excess voltage such as the voltage serge which exceed the maximum rating is added, for example, may destroy the circuit. Accordingly, be careful of handling this product or of surge voltage in its application environment.

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#### **Description of Protection Function**

(1) Under voltage protection

This product incorporates the under voltage protection circuit to prevent the IGBT from operating in unsaturated mode when the  $V\,CC$  voltage or the  $V\,BS$  voltage drops.

When the VCC power supply falls to this product internal setting (VCCUVD = 11 V typ.), all IGBT outputs shut down regardless of the input. This protection function has hysteresis. When the VCCUVR (= 11.5 V typ.) reaches 0.5 V higher than the shutdown voltage, this product is automatically restored and the IGBT is turned on again by the input.

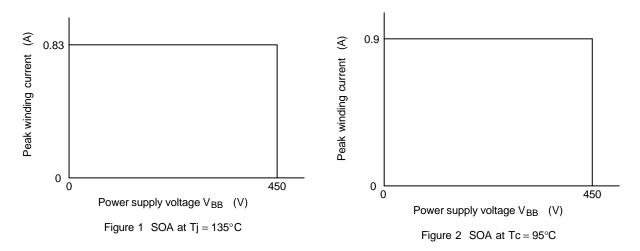
When the VBS supply voltage drops (VBSUVD = 9 V typ.), the high-side IGBT output shuts down. When the VBSUVR (= 9.5 V typ.) reaches 0.5 V higher than the shutdown voltage, the IGBT is turned on again by the input signal.

(2) Thermal shutdown

This product incorporates the thermal shutdown circuit to protect itself against the abnormal state when its temperature rises excessively.

When the temperature of this chip rises due to external causes or internal heat generation and the internal setting TSD reaches 150°C, all IGBT outputs shut down regardless of the input. This protection function has hysteresis ( $\Delta TSD = 50$ °C typ.). When the chip temperature falls to TSD –  $\Delta TSD$ , the chip is automatically restored and the IGBT is turned on again by the input. Because the chip contains just one temperature detection location, when the chip heats up due to the IGBT, for example, the differences in distance from the detection location in the IGBT (the source of the heat) cause differences in the time taken for shutdown to occur. Therefore, the temperature of the chip may rise higher than the thermal shutdown temperature when the circuit started to operate.

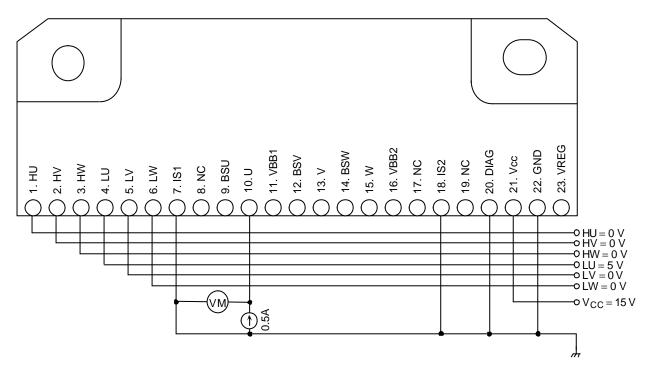
#### **Safe Operating Area**



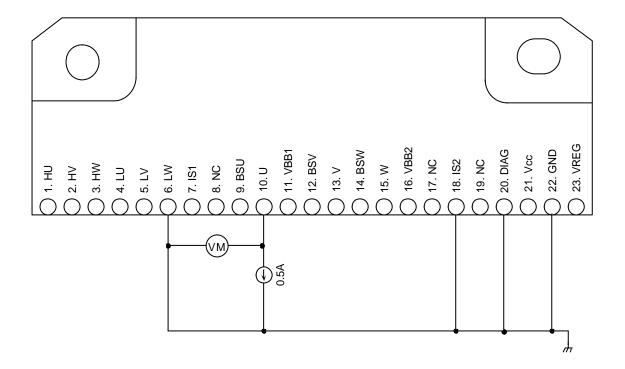
Note 1: The above safe operating areas are Tj = 135°C (Figure 1) and Tc = 95°C (Figure 2). If the temperature exceeds these, the safe operation areas reduce.

#### **Test Circuits**

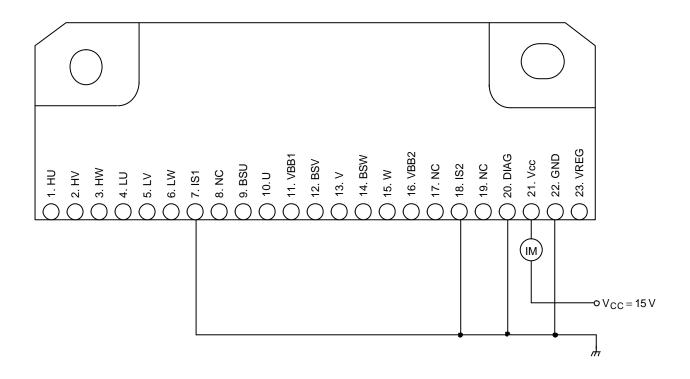
## IGBT Saturation Voltage (U-phase low side)



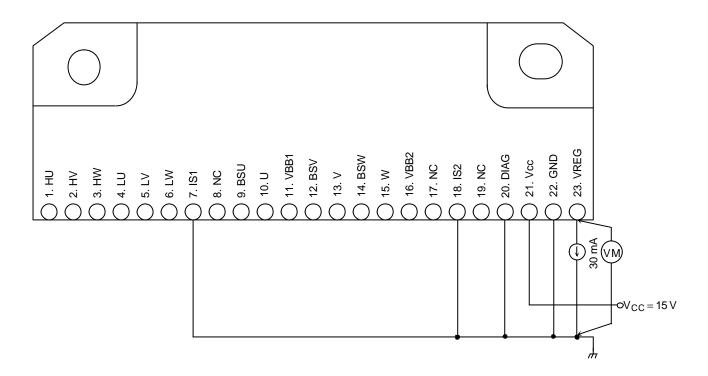
## FRD Forward Voltage (U-phase low side)



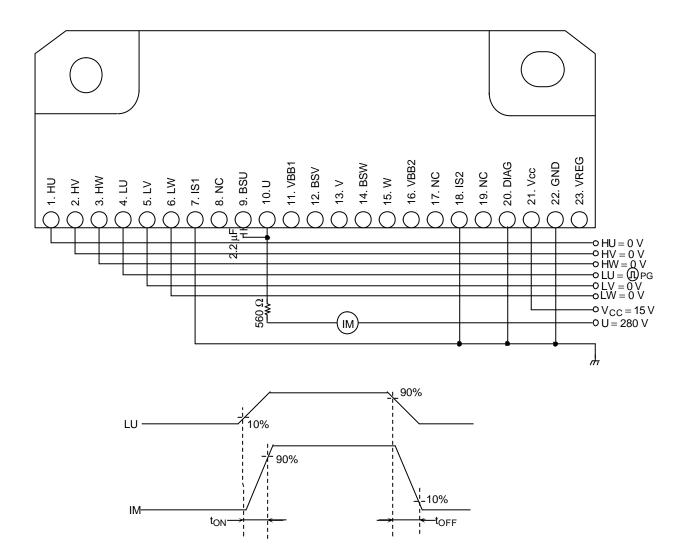
## **V<sub>CC</sub>** Current Dissipation



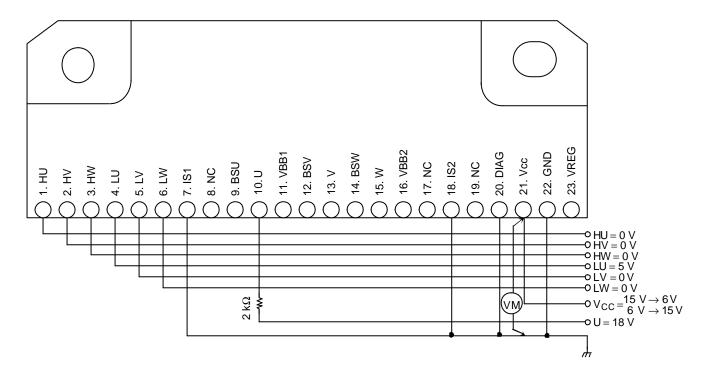
## **Regulator Voltage**



## Output ON/OFF Delay Time (U-phase low side)



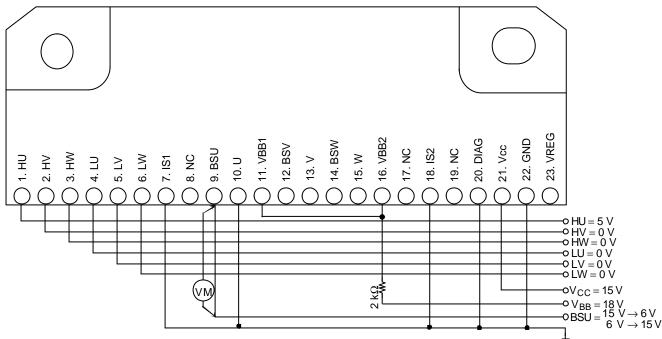
#### V<sub>CC</sub> Under voltage Protection Operation/Recovery Voltage (U-phase low side)



\*:Note:Sweeps the VCC pin voltage from 15 V to decrease and monitors the U pin voltage.

The  $V_{CC}$  pin voltage when output is off defines the under voltage protection operating voltage. Also sweeps from 6 V to increase. The  $V_{CC}$  pin voltage when output is on defines the under voltage protection recovery voltage.

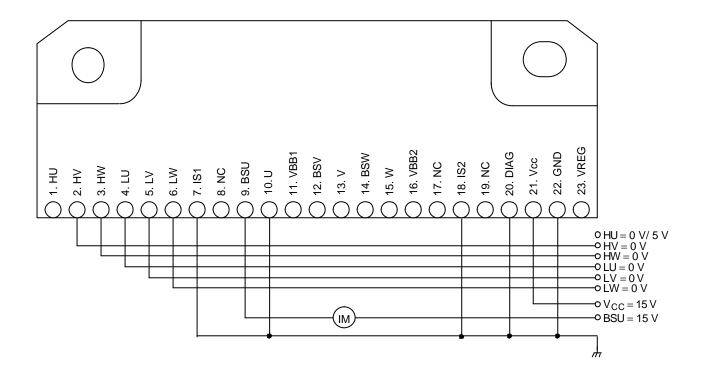
#### V<sub>BS</sub> Under voltage Protection Operation/Recovery Voltage (U-phase high side)



\*:Note:Sweeps the BSU pin voltage from 15 V to decrease and monitors the VBB pin voltage.

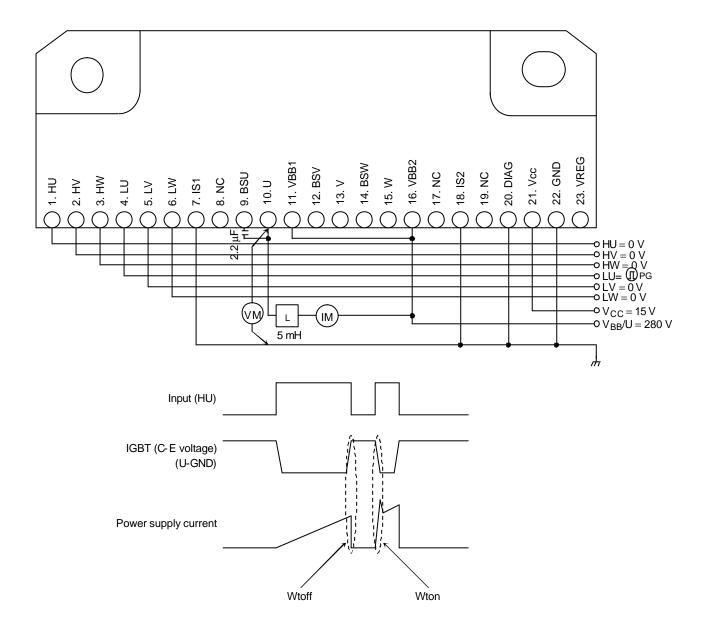
The BSU pin voltage when output is off defines the under voltage protection operating voltage. Also sweeps the BSU pin voltage from 6 V to increase and change the HU pin voltage at 0 V  $\rightarrow$  5 V  $\rightarrow$  0 V. The BSU pin voltage when output is on defines the under voltage protection recovery voltage.

## V<sub>BS</sub> Current Consumption (U-phase high side)



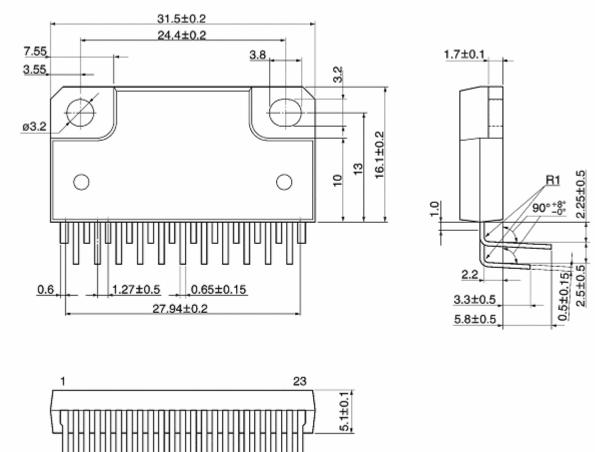
## Turn-On/Off Loss (low-side IGBT + high-side FRD)

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## **Package Dimensions**

HZIP23-P-1.27F Unit: mm

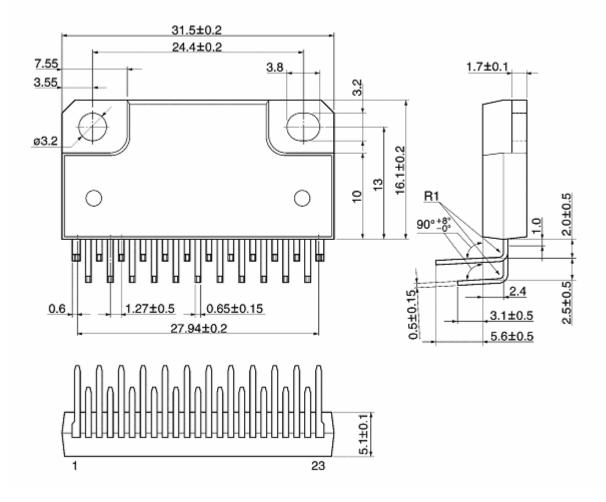


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Weight: 6.1 g (typ.)

## **Package Dimensions**

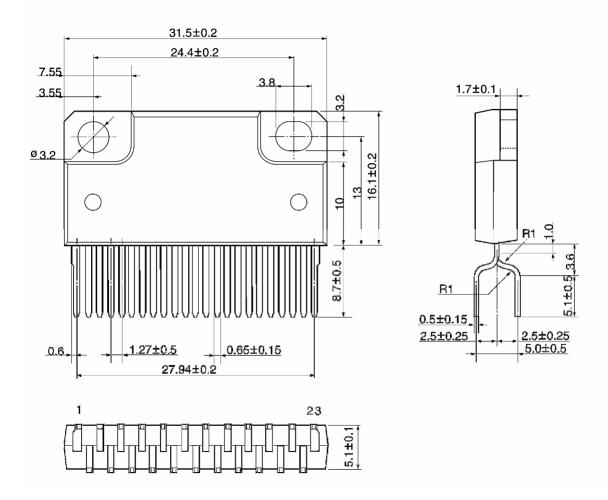
HZIP23-P-1.27G Unit: mm



Weight: 6.1 g (typ.)

## **Package Dimensions**

HZIP23-P-1.27H Unit: mm



Weight: 6.1 g (typ.)

#### **RESTRICTIONS ON PRODUCT USE**

Handbook" etc..

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